



## Product/Process Change Notice - PCN 21\_0021 Rev. -

Analog Devices, Inc. Three Technology Way Norwood, Massachusetts 02062-9106

This notice is to inform you of a change that will be made to certain ADI products (see Appendix A) that you may have purchased in the last 2 years. **Any inquiries or requests with this PCN (additional data or samples) must be sent to ADI within 30 days of publication date.** ADI contact information is listed below.

**PCN Title:** Correction of Package Outline Drawing for Select HMC Products in Carsem in the 8L SOIC E-Pad Package

**Publication Date:** 29-Jan-2021

**Effectivity Date:** 29-Jan-2021 *(the earliest date that a customer could expect to receive changed material)*

**Revision Description:**  
Initial Release.

**Description Of Change:**

Package outline drawing in the product data sheet is being revised from standard lead stand-off height (4-10 mils) to lower lead stand-off height (0-5 mils)

**Reason For Change:**

Original stand-off height prior to product transfer to Carsem in Sept 2019, was 0-5 mils. The affected HMC parts listed in this PCN were produced in Carsem using the standard stand-off height (4-10 mils) since the transfer. ADI is rectifying the error in stand-off height specification to mitigate the risk to customers who may be soldering the E-pad onto the board.

**Impact of the change (positive or negative) on fit, form, function & reliability:**

Lower lead stand-off height will have positive impact to customers' E-pad board mounting quality.

**Product Identification** *(this section will describe how to identify the changed material)*

Parts with low stand-off will be identified with a cut-off date code.

**Summary of Supporting Information:**

No additional qualification required.

**Supporting Documents**

**Attachment 1: Type:** Detailed Change Description

ADI\_PCN\_21\_0021\_Rev\_-\_8L SOIC E-pad POD revision details.pdf

**For questions on this PCN, please send an email to the regional contacts below or contact your local ADI sales representatives.**

**Americas:**  
PCN\_Americas@analog.com

**Europe:**  
PCN\_Europe@analog.com

**Japan:**  
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**Rest of Asia:**  
PCN\_ROA@analog.com

**Appendix A - Affected ADI Models****Added Parts On This Revision - Product Family / Model Number (18)**

HMC361G / HMC361S8G	HMC361G / HMC361S8GE	HMC361G / HMC361S8GETR	HMC361G / HMC361S8GTR	HMC362G / HMC362S8G
HMC362G / HMC362S8GE	HMC362G / HMC362S8GETR	HMC362G / HMC362S8GTR	HMC363G / HMC363S8G	HMC363G / HMC363S8GE
HMC363G / HMC363S8GETR	HMC363G / HMC363S8GTR	HMC365G / HMC365S8G	HMC365G / HMC365S8GE	HMC365G / HMC365S8GETR
HMC365G / HMC365S8GTR	HMC754 / HMC754S8GE	HMC754 / HMC754S8GETR		

**Appendix B - Revision History**

<b>Rev</b>	<b>Publish Date</b>	<b>Effectivity Date</b>	<b>Rev Description</b>
Rev. -	29-Jan-2021	29-Jan-2021	Initial Release.

Analog Devices, Inc.

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